SHEET U.S. DEPARTMENT OF COMMERCE Patent and Trademark Office inched original documents or copy thereof. Name and address of receiving party(ies): Taiwan Semiconductor Manufacturing Co. Ltd. No. 121 Park Avenue 3 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C.
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Additional name(s) & address(es) attached □ Yes Ø No
e execution date of the application is: 02-27-03
B. Patent No(s)
ned? □ Yes ⊠ No
Total number of applications and patents involved:
Total fee (37 CFR 3.41) \$40.00
□ Enclosed
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n is true and correct and any attached copy is a true copy of
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Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents & Trademarks, Box Assignments

Washington, D.C. 20231

67,200-1039 2002-0856

ASSIGNMENT

WHEREAS, we, HAO-YU CHEN, YEE-CHIA YEO and FU-LIANG YANG, have

invented certain improvements in MULTIPLE-GATE TRANSISTOR STRUCTURE AND

METHOD FOR FABRICATING for which an application for a United States Patent was filed on

December 6, 2002, Application Serial No. 10/314,249; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of

No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of

acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and

valuable consideration, the receipt of which is hereby acknowledged, we, HAO-YU CHEN, YEE-

CHIA YEO and FU-LIANG YANG, by these presents, do hereby sell, assign and transfer unto the

said corporation and its assigns, for the territory of the United States of America and all foreign

countries, the entire right, title and interest, including all priority rights under the International

Convention associated with each country of the Union, in and to said invention as described in the

patent application executed by us on the 27th day of Feb. and the 3rd day of Mar., 2003, preparatory

to obtaining Letters Patent of the United States thereon, and in and to said application and any

Letters Patent that may be granted in pursuance of said application and any divisional, continuation

or continuation-in-part application thereof, and in and to any reissue of any such patent, and in and

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any patent applications which may be filed on said invention in countries foreign to the United States

and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention

in its own name or through its designees, including subsidiaries, related companies or assignees.

under the International Convention or otherwise, and we further agree to execute all papers,

including those required for the United States and foreign applications, and to perform such other

proper acts as said corporation or its designees the rights herein assigned.

FU-LIANG VANG Jang

HAO-YU CHEN YEE-CHIA YEO

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302

RECORDED: 04/18/2003

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